

SPZB260ADP

Adapter board

Features

- Easy interface for SPZB260 module
- Single supply from 2.1 to 3.6 V
- Two 6-pin connectors to access EZSP
- 10 pin InSight™ port connector for debug
- Access to SIF signals
- Access to the InSight[™] Desktop packet trace interface
- LEDs for link activity indication



Description

SPZB260ADP is the adapter board for the ZigBee® module SPZB260.

It provides an easy way to interface the SPZB260 module with the development kit during the development and deployment phase of a ZigBee[®] application.

It contains two 6 pins connectors to access the EmberZNet[™] serial protocol (EZSP) and the SPZB260 module SPI, SIF signals and voltage supply; in addition a keyed 10 pin connector allow the connectivity of the SIF and PTI signals with the InSight[™] Desktop for debug.

A LED indicator is driven by a Link Activity signal to provide a visual indication of the module behavior.

As SPZB260ADP is a passive interface of the SPZB260 module, for the electrical characteristics, please refer to the SPZB260 module datasheet.

Contents SPZB260ADP

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1 Recommended operating conditions

Table 1. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|-------------------------------|----------------------|------|-----|------|------|
| VDD | Board supply voltage | - 40 °C < T < +85 °C | 2.1 | 3 | 3.6 | V |
| T _{STG} | Operating ambient temperature | | - 40 | | + 85 | °C |

2 Connections

2.1 J1 connector

J1 is the 10-pin, dual-row, 0.05-inch pitch InSight™ connector provided for programming and debug interface of the SPZB260 module. It contains the four SIF signals (SIF_MOSI, SIF_MISO, SIF_LOADB, SIF_CLK), two packet trace signals (PTI_EN and PTI_DATA), voltage and ground connections.

Through the InSight[™] port cable, it connects directly to the InSight[™] Adapter, which allows programming and debug access within InSight[™] Desktop.

The part used on the adapter is from Samtec (MFG P/N: FTSH-105-01-F-DV-K); it is keyed to guarantee the right connection with the InSight™ port cable.

Figure 1. InSight™ port pin out (J1)

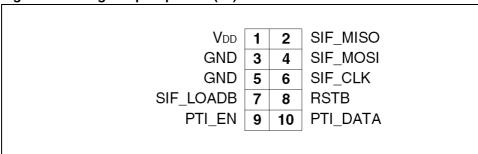
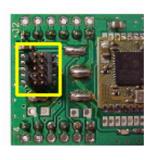


Figure 2. J1 connector



Connections SPZB260ADP

Table 2. InSight™ port pins (J1)

| Pin number | Signal name | Direction | Description |
|------------|-------------|-----------|---|
| 1 | Vdd | Power | 2.1 to 3.6 V supply voltage |
| 2 | SIF_MISO | Output | Serial interface, master in / slave out |
| 3 | GND | Power | Ground connection |
| 4 | SIF_MOSI | Input | Serial interface, master out/ slave in |
| 5 | GND | Power | Ground connection |
| 6 | SIF_CLK | Input | Serial interface, clock signal |
| 7 | SIF_LOADB | I/O | Serial interface, load strobe |
| 8 | RSTB | Input | Active low reset |
| 9 | PTI_EN | Output | Packet trace frame signal |
| 10 | PTI_DATA | Output | Packet trace data signal |

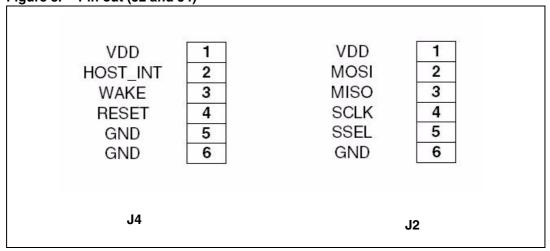
2.2 J2 and J4 connectors

Two 6 pin, single -row, 0.1-inch (2.54 mm) pitch connector on the bottom side of the adapter allows access to the SPZB260US module by means a synchronous (SPI) or asynchronous (UART) serial line.

This connector attaches directly to the Breakout Board and provides a robust and stable interface to the host microcontroller.

J2 and J4 are 2.54 mm pitch header (i.e Molex: 22-28-4063).

Figure 3. Pin out (J2 and J4)



SPZB260ADP Connections

Figure 4. J2 and J4 connector

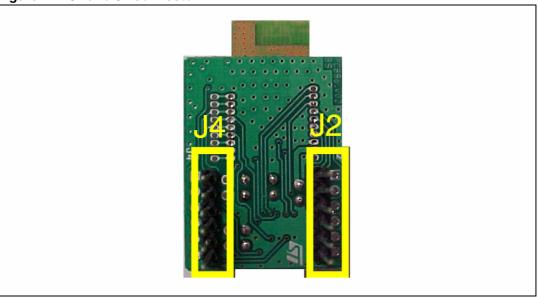


Table 3. J2 pins

| Pin number | Signal name | Direction | Description |
|------------|-------------|-----------|--|
| 1 | VDD | Power | 2.1 to 3.6 V supply voltage |
| 2 | MOSI | Input | SPI data, master out/ slave in (from Host to SPZB260) |
| 3 | MISO | Output | SPI data, master in / slave out (from SPZB260 to Host) |
| 4 | SLCK | Input | SPI clock (Host to SPZB260) |
| 5 | SSEL | Input | Active low SPI slave select (Host to SPZB260) |
| 6 | GND | Power | Ground connection |

Table 4. J4 pins

| Pin number | Signal name | Direction | Description |
|------------|-------------|-----------|--|
| 1 | VDD | Power | 2.1 to 3.6 V supply voltage |
| 2 | HOST_INT | Output | Host interrupt (from SPZB260 to Host) |
| 3 | WAKE | Input | Wake interrupt (from Host to SPZB260) |
| 4 | RSTB | I/O | Active low chip reset |
| 5 | GND | Power | Ground connection |
| 6 | GND | Power | Ground connection |

Device description SPZB260ADP

3 Device description

3.1 LED indicator

A LED indicator, L1, is provided on the adapter; this LED is connected to the SPZB260 module (pin 16) which make available the Activity signal giving a visual indication of the behavior of the module.

3.2 Jumpers

Six jumpers are provided on the adapter:

- JP1 between pin 1 of J2 connector and SPZB260 power supply pin
- JP2 between pin 1 of J4 connector and SPZB260 power supply pin
- JP3 between pin 1 of J1 connector ("10 pin InSight™ connector") and SPZB260 power supply pin

These jumpers can be used to separate the voltage supply source and to measure the current consumption; in normal operation they should be closed.

3.3 Configuration jumpers

Module SPZB260

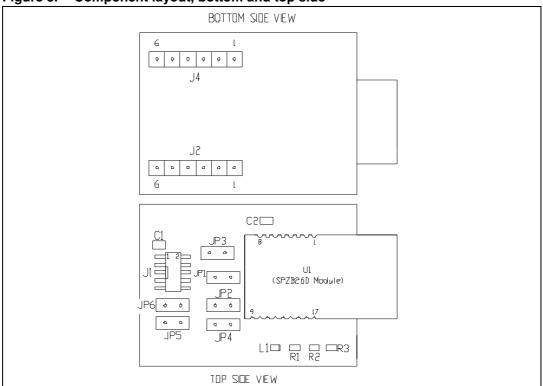
JP4 JP5: open

- JP6: closed

SPZB260ADP Device description

3.4 Adapter layout

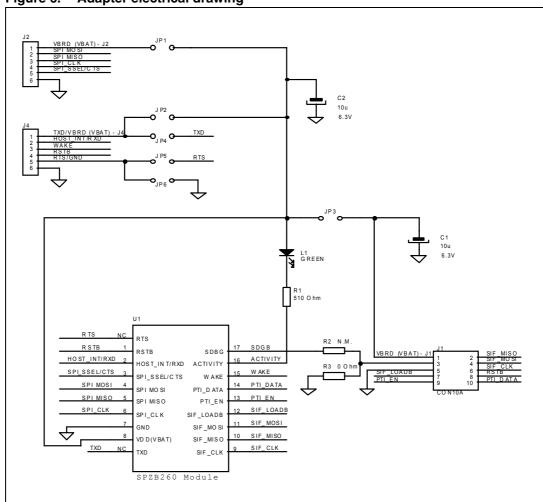
Figure 5. Component layout, bottom and top side



Electrical drawing SPZB260ADP

4 Electrical drawing

Figure 6. Adapter electrical drawing



SPZB260ADP **Mechanical drawing**

Mechanical drawing 5

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

TOP SIDE VIEW 2.54 pitch SPZB26D Module 76.5 6 65 35 5 4215

Figure 7. Adapter mechanical drawing

Revision history SPZB260ADP

6 Revision history

Table 5. Document revision history

| Date | Revision | Changes |
|-------------|----------|---------------|
| 18-Apr-2008 | 1 | First release |

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